

# Model name: PT850GT01-2

Date: 2. Sep. 2021

( ) Preliminary Specification

( ) Final Specification

Any modification is not allowed without HKC's permission

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**Revision History**

Version	Date	Page (New)	Section	Description	Revision by
Rev. P1	2021/8/16	-	All	Preliminary Specification was first issued.	
Rev. F.1	2021/8/31	22	All	Optical spec update	RD

Conditional

## 1. GENERAL DESCRIPTION

The specification is applied to 85" model (PT850GT01-2) TFT Liquid Crystal Display open cell and it supports 3840x2160 UD mode with 1.07G (8bit+FRC) colors. This product is with driver ICs and a 51-pins-8 lane-VBO circuit board and built in without backlight unit.

### 1.1 General Specifications

Item	Specification	Unit	Note
<b>Screen Size</b>	85 inch Diagonal	-	-
<b>Outline Dimension</b>	1884.12 ( H ) ×1067.06 ( V )	mm	-
<b>Active Area</b>	1872 ( H ) ×1053 ( V )	mm	
<b>Driver Element</b>	a-si TFT active matrix	-	-
<b>Cell Transmittance</b>	5.5%	%	HKC light , Center point
<b>Pixel Number</b>	3840×2160	pixel	-
<b>Sub Pixel Pitch</b>	0.1625(H)×0.4875(V)	mm	-
<b>Pixel Arrangement</b>	RGB vertical stripe	-	-
<b>Display Colors</b>	1.07G	Color	8bit+FRC
<b>Display Mode</b>	Normally Black	-	-
<b>Display Orientation</b>	Signal input with "ABC"	-	-
<b>Panel Inversion Type</b>	Column inversion	-	-
<b>Surface Treatment</b>	Type=AG	-	-
	Haze=2.3%	-	-
	Top surface Hardness:3H	-	-
<b>Weight</b>	5.93	Kg	-

Note:

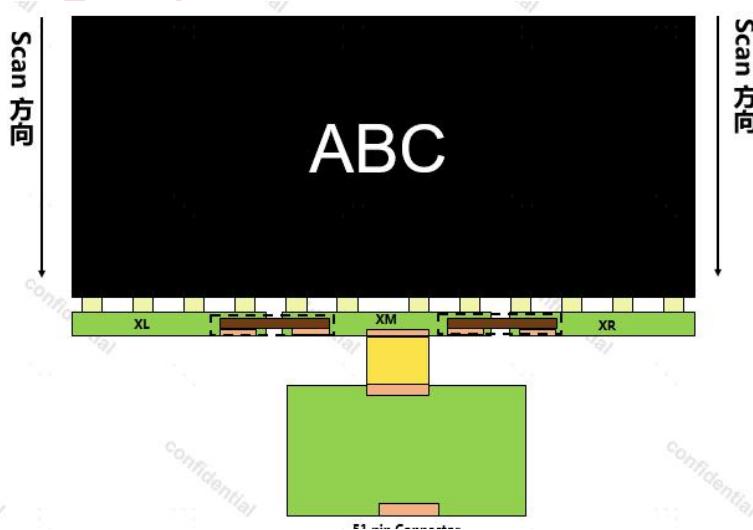


Fig 1.1 Display Orientation

## 2. ABSOLUTE MAXIMUM RATINGS

### 2.1 Absolute Maximum Ratings

The followings are maximum values which, if exceeded, may cause damage to the unit.

Item	Symbol	Value		Unit	Note
		Min.	Max.		
Power Supply Voltage	V <sub>CC</sub>	-0.3	13.5	V	(1)
Input Signal Voltage	V <sub>in</sub>	-0.3	3.6	V	(1)

Note:

- (1) Within Ta=25±2°C

### 2.2 Absolute Ratings Of Environment

Temperature and relative humidity range are shown in the figure below.

Item	Symbol	Value		Unit	Note
		Min.	Max.		
Storage Temperature	TST	-20	60	°C	(1)
Operating Temperature	TOP	0	50	°C	(1), (2)

Note:

- (1) a. 90 % RH Max. (Ta ≤ 40 °C).
  - b. Web-bulb temperature should be 39°C Max. (Ta>40°C)
  - c. No condensation
  - d. Operating condition with a assemble module
- (2) Any point on the Driver surface must be less than 120 °C under any condition ,If the surface temperature is out of the spec, thermal solutions should be applied to avoid be damaged.
- (3) Surface temperature of display area is measured at 50°C dry condition.

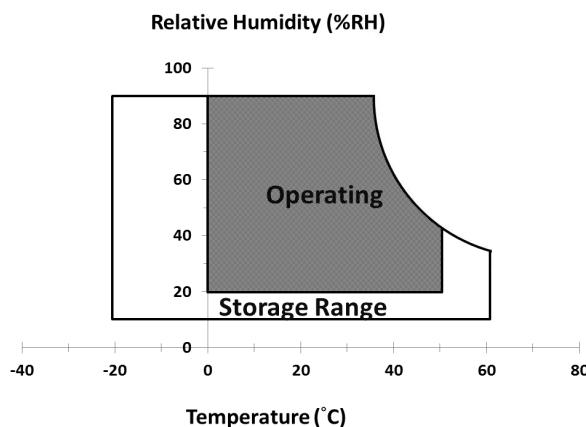


Fig. 2.1 Operating and storage environment

### 2.3 Package Storage

When storing open cell as spares for a long time, please follow the precaution instructions:

- (1) Do not store the open cell in high temperature and high humidity for a long time. It is highly recommended to store the module with temperature from 20°C to 30°C in normal humidity (50 ± 10%RH) with shipping package.
- (2) The open cell should be keep within one month shelf life.

Conditional

### 3. ELECTRICAL SPECIFICATIONS

#### 3.1 Electrical Characteristics

##### 3.1.1 Power Consumption

Parameter	Symbol	Value			Unit	Note
		Min.	Typ.	Max.		
Power Supply Voltage	V <sub>CC</sub>	10.8	12	13.2	V	(1)
Rush Current	I <sub>RUSH</sub>			5	A	(2)
Power Supply Current	White Pattern	-		0.89	1.16	A
	Horizontal Strip	-		3.1	4.03	A
	Black Pattern	-		0.85	1.11	A

Note:

- (1) Ambient temperature:  $25 \pm 2^\circ\text{C}$
- (2) The ripple voltage should be controlled under 10% of V<sub>CC</sub>.
- (3) Measurement Conditions: V<sub>CC</sub> rising time = 470μs.

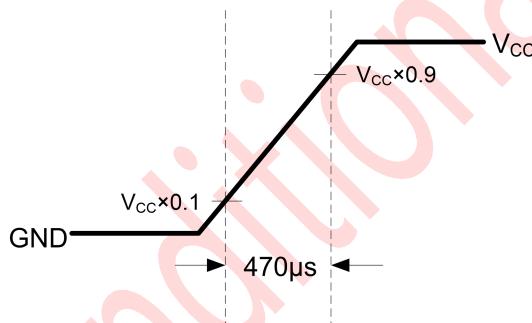


Fig.3.1 Vcc rising time condition

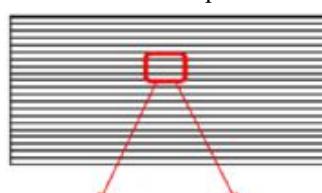
- (4) Measurement Conditions: V<sub>CC</sub> = 12V, Ta = 25 ± 2 °C, Fv = 60 Hz, whereas the test pattern is shown as below.

The heavy load pattern is figure B.

A. White Pattern



B. Horizontal Strip



C. Black Pattern



Fig.3.2 Test patterns

### 3.1.2 V By One Characteristics

Parameter	Symbol	Value			Unit	Note
		Min.	Typ.	Max.		
V by one Interface	VTH	-	-	+50	mV	-
	VTL	-50	-	-	mV	-
	TTOSK_intra	-0.3	-	0.3	UI	(1)
	TTOSK_inter	-5	-	5	UI	(2)
	30KHz modulation	-0.5	-	+0.5	%	(3)(4)
	FSSM		30K	-	Hz	
CMOS Interface	V	200	-	400	mV	-
	VIH	2.4	-	3.3	V	-
	VIL	0	-	0.6	V	-
	Data rate	-	-	2.97	Gbps	-
	Loop bandwidth	-	-	10	MHZ	-
	Damping factor	-	-	1	-	-

Note:

(1) Intra-pair skew

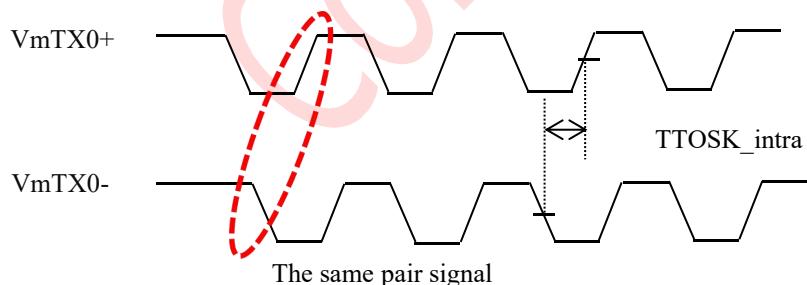


Fig. 3.3 V by one Intra-pair skew

(2) Inter-pair skew

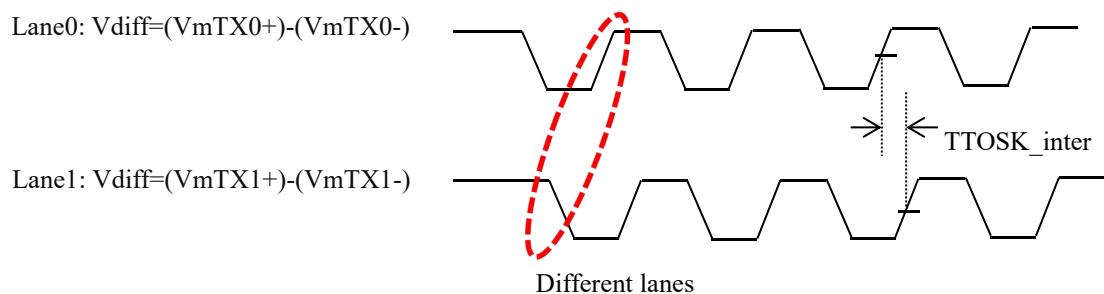


Fig. 3.4 V by one Inter-pair skew

(3) The SSCG (Spread Spectrum Clock Generator) is defined as the following figure.

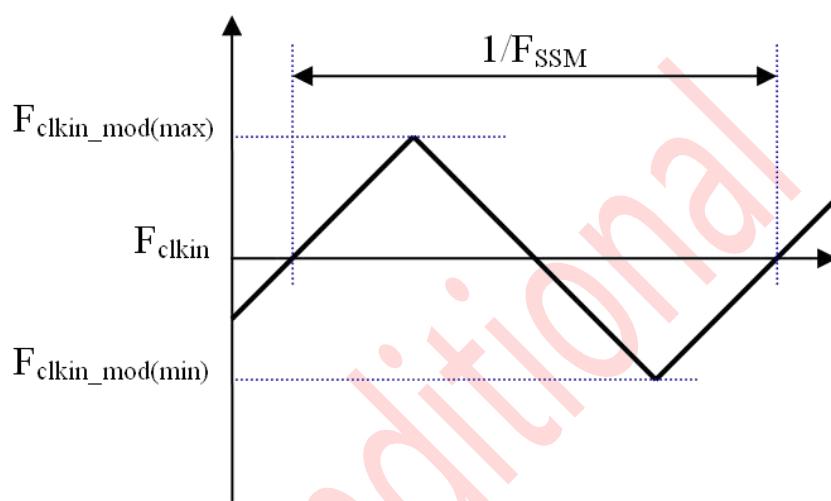


Fig. 3.5 Spread Spectrum Clock Generator

(4) The V by one SSM's suggestion is off by default, SOC board must test all validation if SOC board open the V by one SSM.

### 3.1.3 V By One Input Signal Timing

Item	X(UI)	Y(mV)	Note
A	0.25	0	(1)
B	0.3	50	(1)
C	0.7	50	(1)
D	0.75	0	(1)
E	0.7	-50	(1)
F	0.3	-50	(1)

Note:

(1)

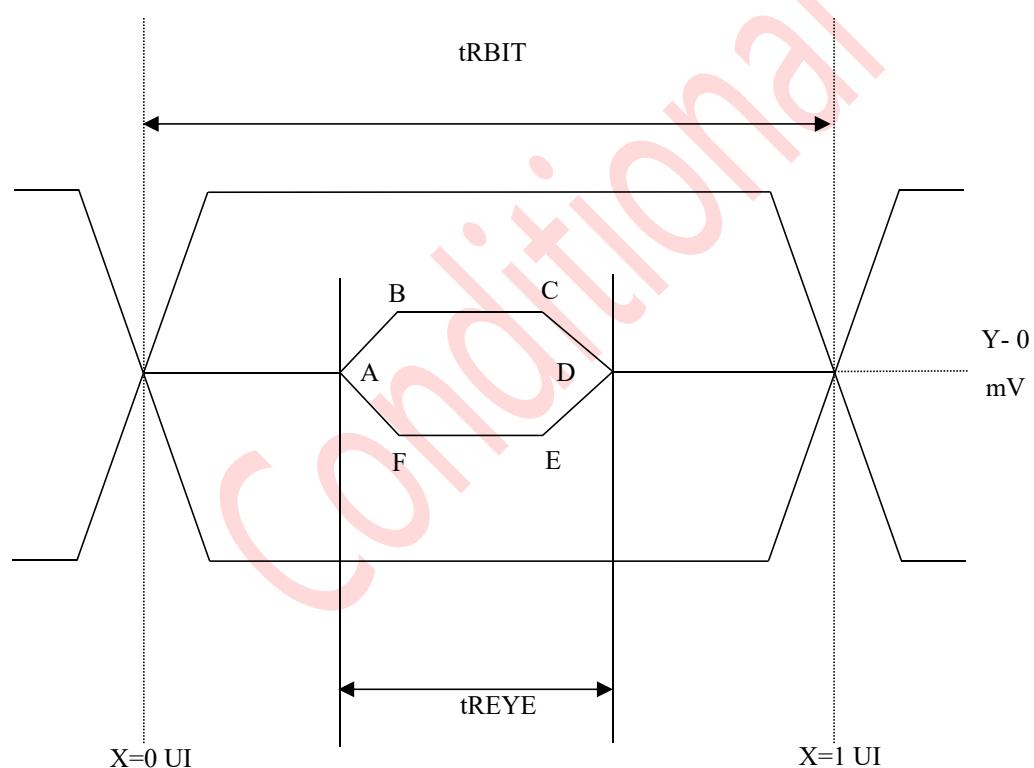


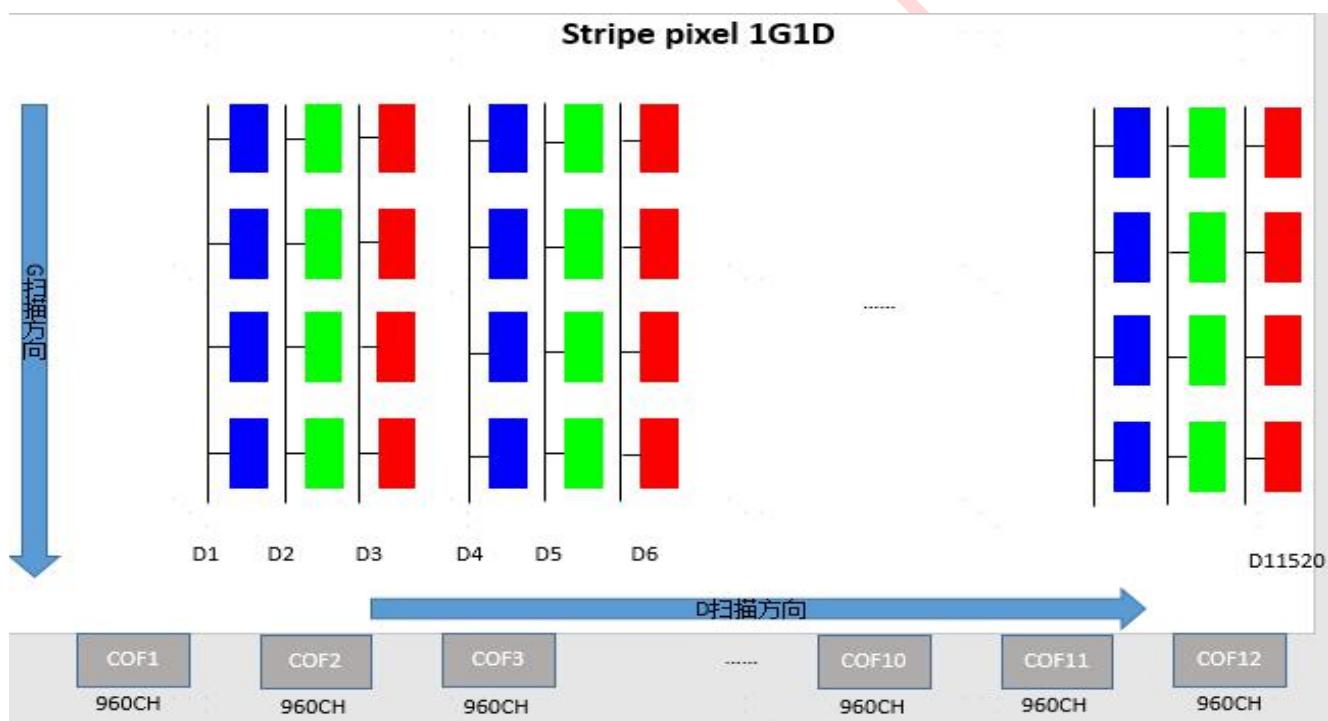
Fig. 3.6 V by one input signal timing

### 3.1.4 V By One Data Mapping

V by One Data Mapping

Lane	Data Stream
Lane 0	Pixel 1, 5, 9, .....1913, 1917
Lane 1	Pixel 2, 6, 10, .....1914, 1918
Lane 2	Pixel 3, 7, 11, .....1915, 1919
Lane 3	Pixel 4, 8, 12, .....1916, 1920
Lane 4	Pixel 1921, 1925, 1929, .....3833, 3837
Lane 5	Pixel 1922, 1926, 1930, .....3834, 3838
Lane 6	Pixel 1923, 1927, 1931, .....3835, 3839
Lane 7	Pixel 1924, 1928, 1932, .....3836, 3840

TFT LCD Panel



### 3.1.5 Color Data Input Assignment

The brightness of each primary color is based on the 10-bit gray scale data input for each color. The higher the binary input, the brighter the color. The table below provides the assignment of the color versus.

Data Input Color		Data Signal																				
		Red										Green										Blue
		MSB					LSB					MSB					LSB					MSB
		R9	R8	R7	R6	R5	R4	R3	R2	R1	R0	G9	G8	G7	G6	G5	G4	G3	G2	G1	G0	LSB
Basic Colors	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	

#### **Attention:**

0: Low level voltage; 1: High level voltage.

### 3.2 Interface Connections

Interface Pin Assignment

CN1: F05035-51P-U (CT) or equivalent (1)

Pin No.	Symbol	Description	Pin No.
1	VIN12	Power input (+12V)	-
2	VIN12	Power input (+12V)	-
3	VIN12	Power input (+12V)	-
4	VIN12	Power input (+12V)	-
5	VIN12	Power input (+12V)	-
6	VIN12	Power input (+12V)	-
7	VIN12	Power input (+12V)	-
8	VIN12	Power input (+12V)	-
9	NC	No Connection	(2)
10	GND	Ground	-
11	GND	Ground	-
12	GND	Ground	-
13	GND	Ground	-
14	GND	Ground	-
15	NC	No Connection	(2)
16	NC	No Connection	(2)
17	NC	No Connection	(2)
18	SDA	I2C Serial Data	-
19	SCL	I2C Serial Clock	
20	WP	Write Protection High(3.3V) for Writable, Open/Low(GND) for Protection	
21	NC	No Connection	
22	NC	No Connection	(2)
23	NC	No Connection	(2)
24	NC	No Connection	(2)
25	HTPDN	Hot Plug Detect	(3)
26	LOCKN	Lock Detect	-
27	GND	Ground	-
28	VB1_Rx0N	V-By One HS Negative Data Lane 0	-
29	VB1_Rx0P	V-By One HS Positive Data Lane 0	-
30	GND	Ground	-
31	VB1_Rx1N	V-By One HS Negative Data Lane 1	-

32	VB1_Rx1P	V-By One HS Positive Data Lane 1	-
33	GND	Ground	-
34	VB1_Rx2N	V-By One HS Negative Data Lane 2	-
35	VB1_Rx2P	V-By One HS Positive Data Lane 2	-
36	GND	Ground	-
37	VB1_Rx3N	V-By One HS Negative Data Lane 3	-
38	VB1_Rx3P	V-By One HS Positive Data Lane 3	-
39	GND	Ground	-
40	VB1_Rx4N	V-By One HS Negative Data Lane 4	-
41	VB1_Rx4P	V-By One HS Positive Data Lane 4	-
42	GND	Ground	-
43	VB1_Rx5N	V-By One HS Negative Data Lane 5	-
44	VB1_Rx5P	V-By One HS Positive Data Lane 5	-
45	GND	Ground	-
46	VB1_Rx6N	V-By One HS Negative Data Lane 6	-
47	VB1_Rx6P	V-By One HS Positive Data Lane 6	-
48	GND	Ground	-
49	VB1_Rx7N	V-By One HS Negative Data Lane 7	-
50	VB1_Rx7P	V-By One HS Positive Data Lane 7	-
51	GND	Ground	-

Note:

(1) direction of pin assignment is shown as below:

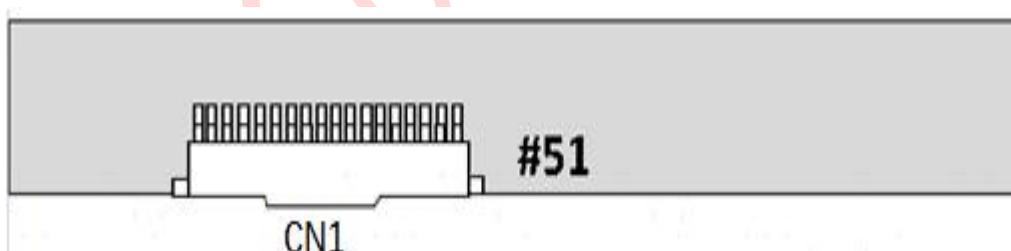
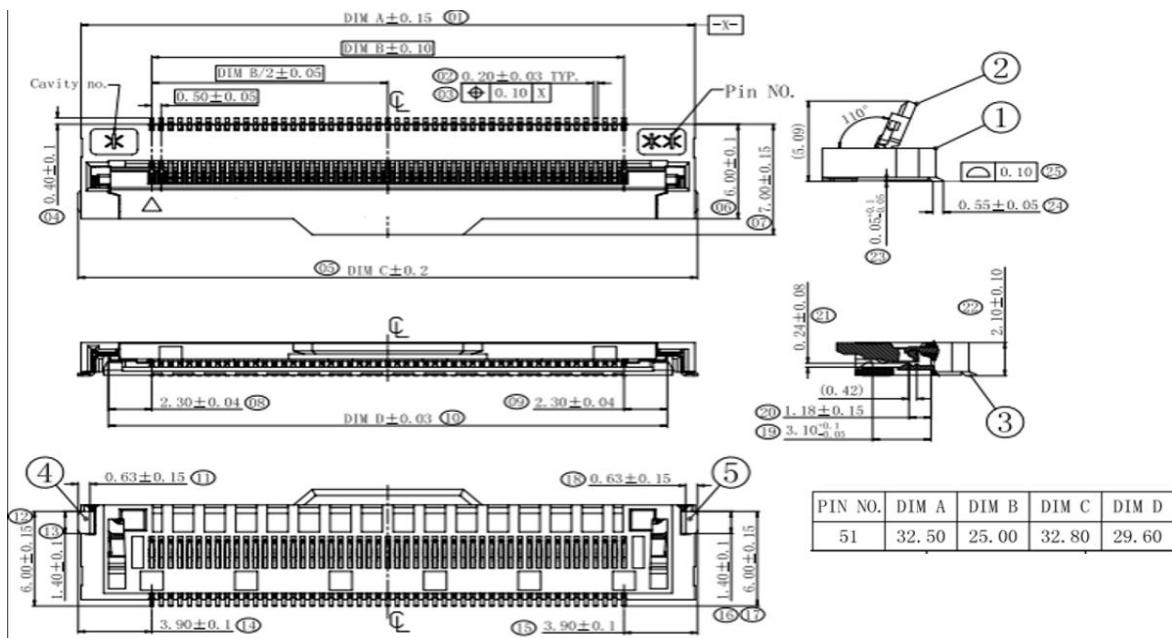


Fig 3.7 Connector direction sketch map

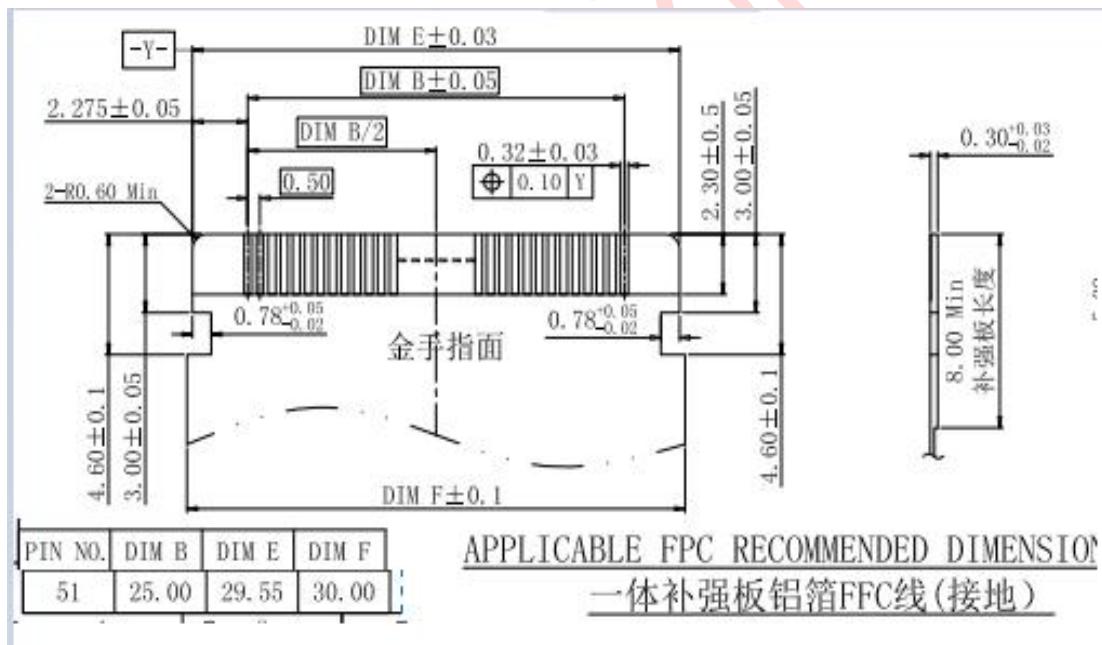
- (2) Reserved internal use. Please leave it open.
- (3) Connect 4.7K resistance to GND

## (4) Connector Drawing

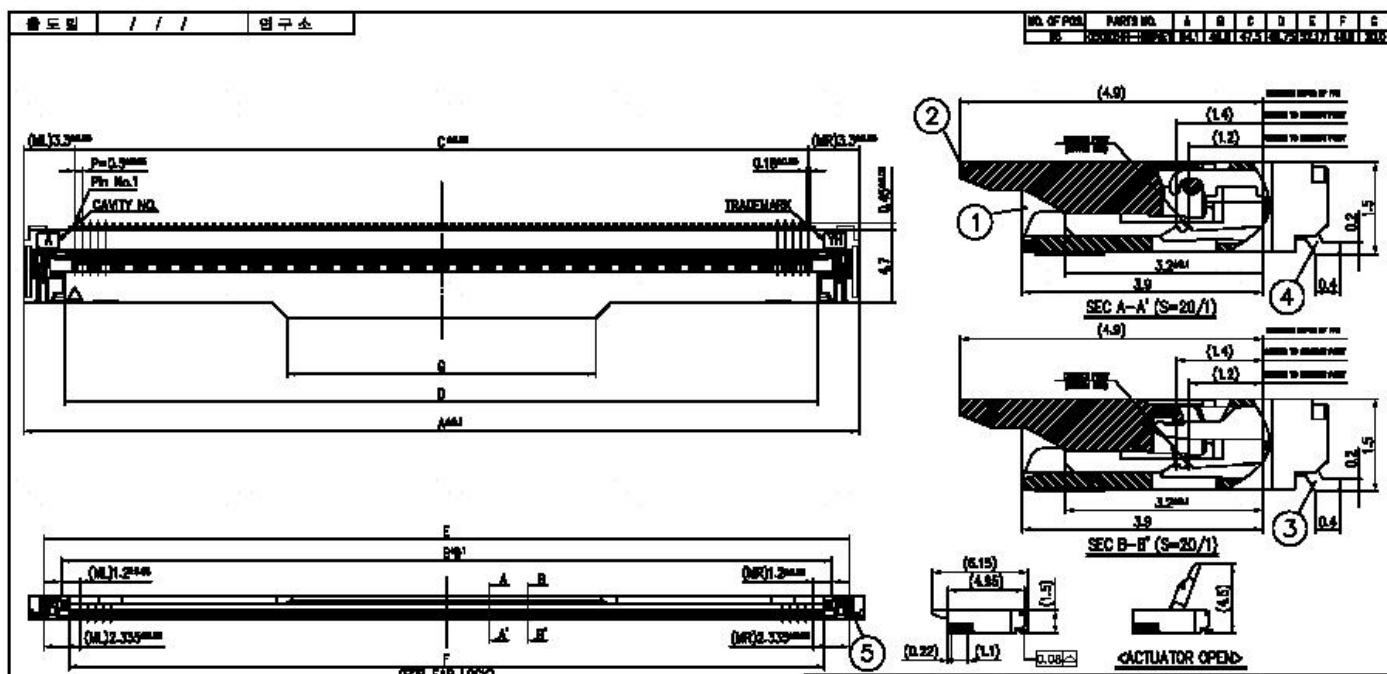
TCON Board Input 51pin Connector Drawing- F05035-51P-U



TCON Board Input 51pin FFC Drawing

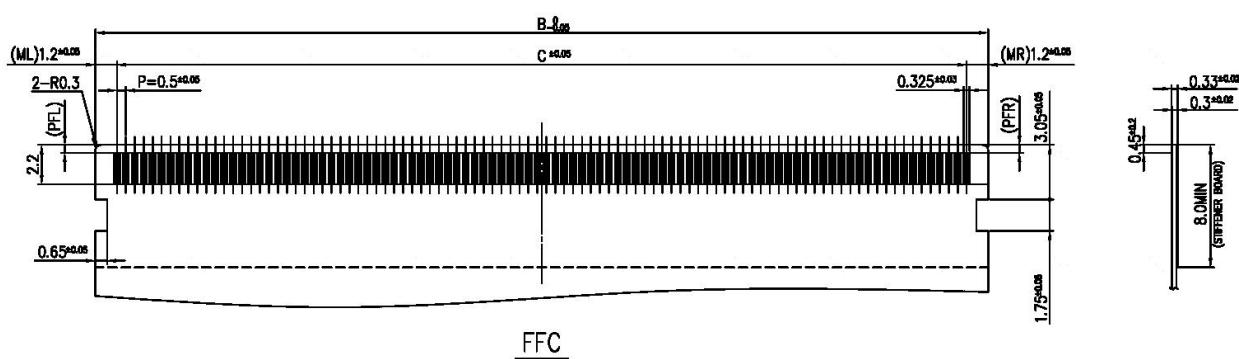


## TCON Board Output 96 pin Connector Drawing- 05002HR-H96VE1(G)



TCON Board Output 96pin FFC Drawing

FFC differential resistance  $RL=100\Omega \pm 10\%$ , FFC recommends a maximum length of 10cm



### 3.3 IC Characteristics

Parameter	Symbol	Values			Unit
		Min	Typ	Max	
TCON Surface Temperature	$T_{TS}$	-	-	100	°C
Driver Surface Temperature	$T_{DS}$	-	-	120	°C
PMIC Surface Temperature	$T_{PS}$	-	-	100	°C

Note :

- (1) Any point on the IC surface must be less than the max value under any conditions.
- (2) This test condition is based on HKC module

### 3.4 Timing Spec

Timing Table (DE Only Mode)

Frame Rate=60Hz

Signal	Item	Symbol	Min.	Typ.	Max.	Unit	Note
Frequency		$F_{CLK}$ (= 1 / $T_{CLK}$ )	71.75	74.25	76.75	MHz	(1)
Frame Rate		$F$	58	60	62	Hz	-
Vertical Term	Total	$T_V$	2200	2250	2350	$T_H$	$T_V = T_{VD} + T_{VB}$
	Display	$T_{VD}$		2160		$T_H$	-
	Blank	$T_{VB}$	40	90	190	$T_H$	-
Horizontal Term	Total	$T_H$	540	550	600	$T_{CLK}$	$T_H = T_{HD} + T_{HB}$
	Display	$T_{HD}$		480		$T_{CLK}$	-
	Blank	$T_{HB}$	60	70	120	$T_{CLK}$	-

Attention:

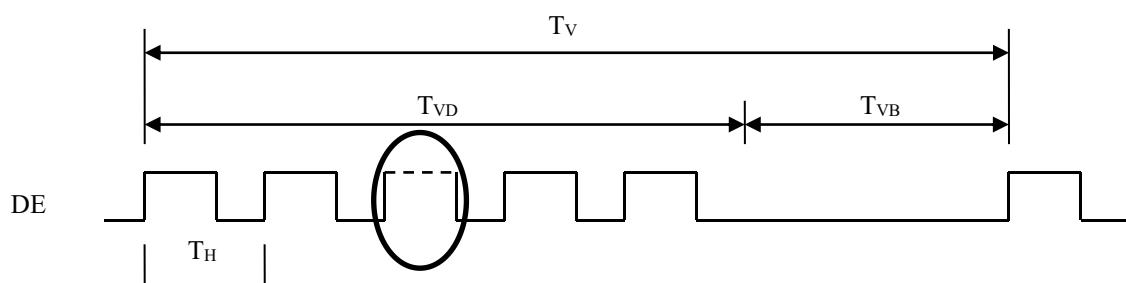
The module is operated in DE only mode, H sync and V sync input signal have no effect on normal operation.

Note:

- (1) Please make sure the range of pixel clock follows the following equations:

$$F_{ClkIn}(\max) \geq F_{max} \times T_V \times T_H$$

$$F_{min} \times T_V \times T_H \geq F_{ClkIn}(\min)$$



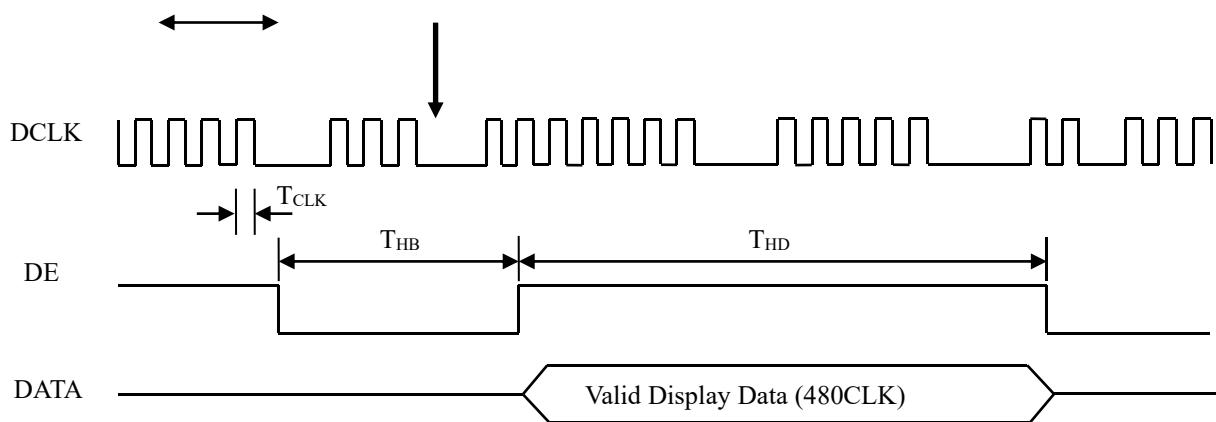


Fig.3.11 Interface signal timing diagram

### 3.5 Power On/Off Sequence

To prevent a latch-up or DC operation of LCD module, the power on/off sequence should be as the diagram below.

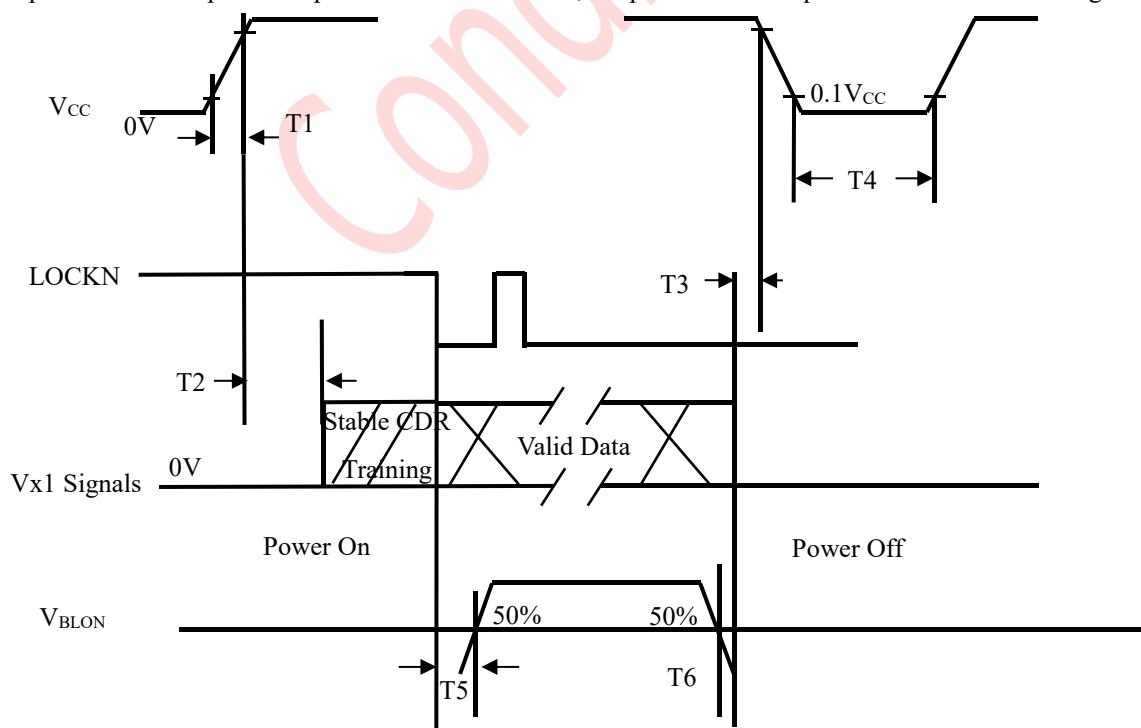


Fig. 3.12 Power on/off sequence

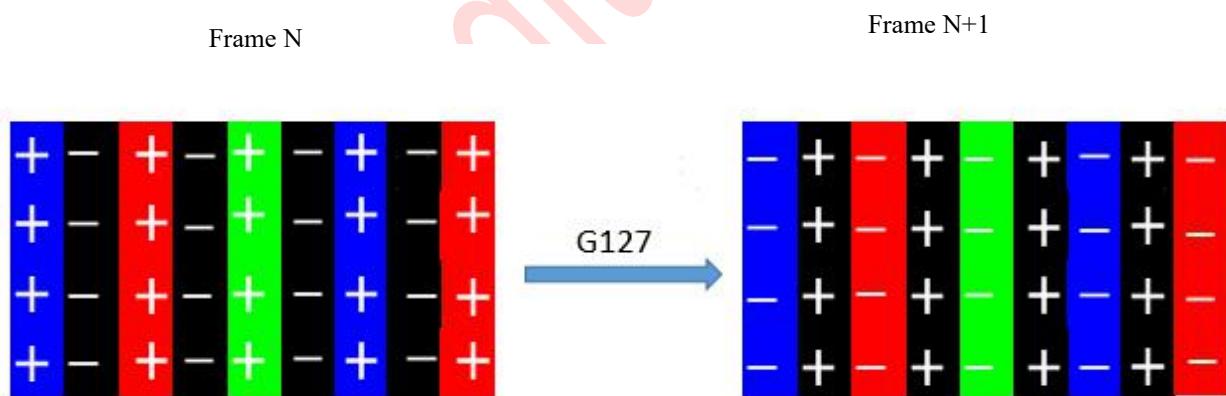
Parameter	Values			Unit
	Min.	Typ.	Max.	
T1	0.5		10.0	ms
T2	0			ms
T3	0			ms
T4	1000			ms
T5	500			ms
T6	100			ms

Attention:

- (1) Apply the light bar voltage within the LCD operation range. When the backlight turns on before the LCD operation or the LCD turns off before the backlight turns off, the display may momentarily become abnormal screen.
- (2) In case that V<sub>CC</sub> is in off level, please keep the level of input signals on the low or high impedance.
- (3) T4 should be measured after the module has been fully discharged between power off and on period.
- (4) Interface signal shall not be kept at high impedance when the power is on.
- (5) The product should be always operated within above ranges.

### 3.6 Flicker Pattern

The Flicker adjustment pattern suggested as below.



Bright sub-pixel=G127(50% grayscale); dark sub-pixel=G0 ( 0%grayscale )

Fig 3.13 Flicker pattern

### 3.7 Driver IC ESD spec

If the LCD module is designed with the Plastic Bezel, we suggest ESD protection solutions should be applied to avoid IC damaged, as shown in Fig.3.14.

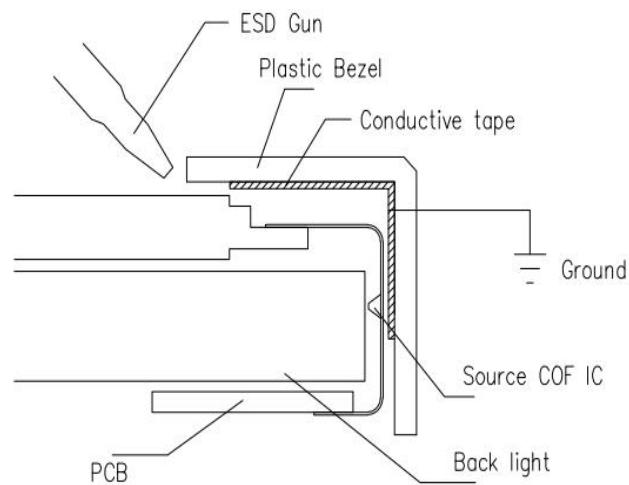


Fig. 3.14 Source COF IC ESD protection

## 4. OPTICAL CHARACTERISTICS

### 4.1 Measurement Conditions

The table below is the test condition of optical measurement.

Item	Symbol	Value	Unit
Ambient Temperature	T <sub>A</sub>	25±2	°C
Ambient Humidity	H <sub>A</sub>	50±10	% RH
Supply Voltage	V <sub>CC</sub>	12	V
Driving Signal	Refer to the typical value in Chapter 3: Electrical Specification		
Vertical Refresh Rate	F <sub>v</sub>	60	Hz
Light source	HKC module White LED Backlight Module/ Film structure		
Warm up time	T <sub>warm</sub>	>30 min	min
Dark room	ED	1lux>	lux

To avoid abrupt temperature change during optical measurement, the measurement should be executed in a stable, windless, in dark room after lighting the light source.

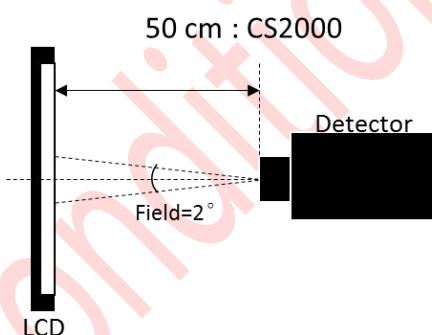


Fig.4.1 Measurement equipment.

## 4.2 Optical Specifications

The relative measurement methods of optical characteristics are shown in 4.2. The following items should be measured under the test conditions described in 4.1 and stable environment shown in 4.1.

		Symbol	Condition	Min.	Typ.	Max.	Unit	Note	
Color Chromaticity (CIE1931)	Red	Rx	$\theta_x=0^\circ, \theta_y=0^\circ$ Viewing Angle at Normal Direction at center point of panel, Light source is HKC Backlight	Typ -0.03	0.641	Typ + 0.03	-	(1)	
		Ry			0.335				
	Green	Gx			0.299				
		Gy			0.628				
	Blue	Bx			0.147				
		By			0.075				
	White	Wx			0.280				
		Wy			0.313				
Transmittance		T%			4.9%	5.5%	-	% (2)	
Color Gamut		NTSC			68%	72%	-	% (3)	
Contrast Ratio		CR	$\theta_x=0^\circ, \theta_y=0^\circ$ With HKC BLU	4000	5000	-	-	(4)	
Response Time		T <sub>g</sub>			-	8.5	16	ms (5)	
Viewing Angle	Horizontal	$\theta_x+$	$CR \geq 10$	-	89	-	Deg. (6)		
		$\theta_x-$			89	-			
	Vertical	$\theta_y+$		-	89	-			
		$\theta_y-$			89	-			

Note:

Light source here is the backlight of HKC Module, and film structure is one diffuser and two prism sheets.

- (1) Each chromaticity coordinates (x, y) are measured in CIE1931 color space when full-screen displaying (Red, Green, Blue, White) and light source is defined by HKC Backlight, measurements shall be made at the center of the panel, and setup of measurement is shown in Fig 4.1.
- (2) The color gamut is defined as the fraction in percent of the area of the triangle bounded by R, G, B coordinates and the area is defined by NTSC 1931 color standard in the CIE color space. Chromaticity coordinates are measured by CS2000 and the standard setup of measurement is shown in Fig 4.1.
- (3) Definition of Transmittance (T%):

The transmittance is measured with full white pattern ( $L_{max}$ ) at the center of the LCD panel.

$$\text{Transmittance (T\%)} = \frac{\text{Luminance of LCD module}}{\text{Luminance of backlight}}$$

(4) Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression,

$$\text{Contrast Ratio (CR)}: CR = \frac{CR_w}{CR_d}$$

$CR_w$  : Luminance of LCD module with full screen white pattern (255,255, 255) at center point.

$CR_d$  : Luminance of LCD module with full screen Dark pattern (0, 0, 0) at center point.

Where the measure point of to the Contrast Ratio is the center of the panel

(5) Definition of Response time (Tg):

Average of gray to gray response time ( $T_g$ ) means the average switching time of luminance ratios among 0%,25%,50%,75%,and 100% to each other and is optimized on frame rate =60Hz.

Measured Response time		To				
		0%	25%	50%	75%	100%
From	0%		$T_{0\% \text{to} 25\%}$	$T_{0\% \text{to} 50\%}$	$T_{0\% \text{to} 75\%}$	$T_{0\% \text{to} 100\%}$
	25%	$T_{25\% \text{to} 0\%}$		$T_{25\% \text{to} 50\%}$	$T_{25\% \text{to} 75\%}$	$T_{25\% \text{to} 100\%}$
	50%	$T_{50\% \text{to} 0\%}$	$T_{50\% \text{to} 25\%}$		$T_{50\% \text{to} 75\%}$	$T_{50\% \text{to} 100\%}$
	75%	$T_{75\% \text{to} 0\%}$	$T_{75\% \text{to} 25\%}$	$T_{75\% \text{to} 50\%}$		$T_{75\% \text{to} 100\%}$
	100%	$T_{100\% \text{to} 0\%}$	$T_{100\% \text{to} 0\%}$	$T_{100\% \text{to} 50\%}$	$T_{100\% \text{to} 75\%}$	

Table 4.2 Switching time of luminance ratios matrix

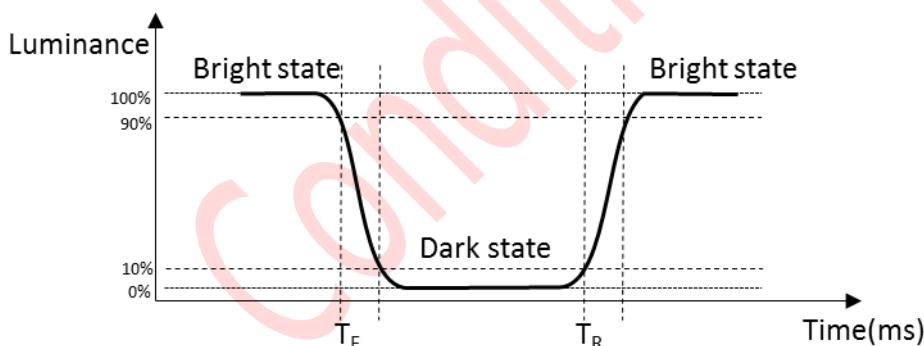


Fig 4.3 The definition of TR and TF

Measured response time is determined by 10% to 90% brightness difference of rising ( $T_R$ ) or falling ( $T_F$ ) time.

(6) Definition of Viewing angle:

As Note (4) the static contrast ratio definition, the viewing angles are defined at the angle that the contrast ratio is larger than 10 at four directions relative to the perpendicular direction of the HKC's module (two vertical angles: up  $\theta_y^+$  and down  $\theta_y^-$ ; and two horizontal angles: right  $\theta_x^+$  and left  $\theta_x^-$ ). The standard setup of measurement is shown in Fig 4.1 & 4.4

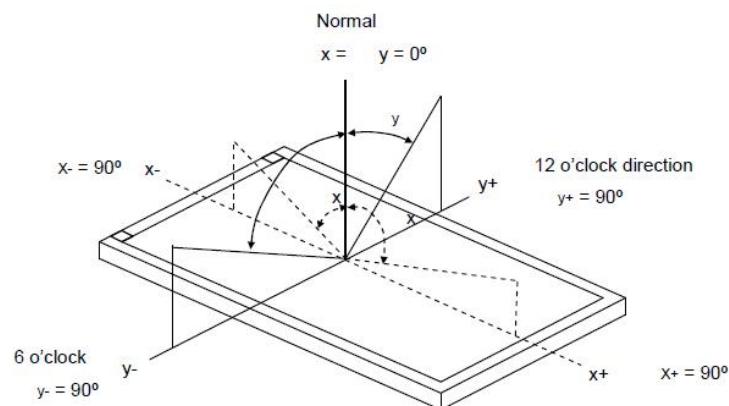
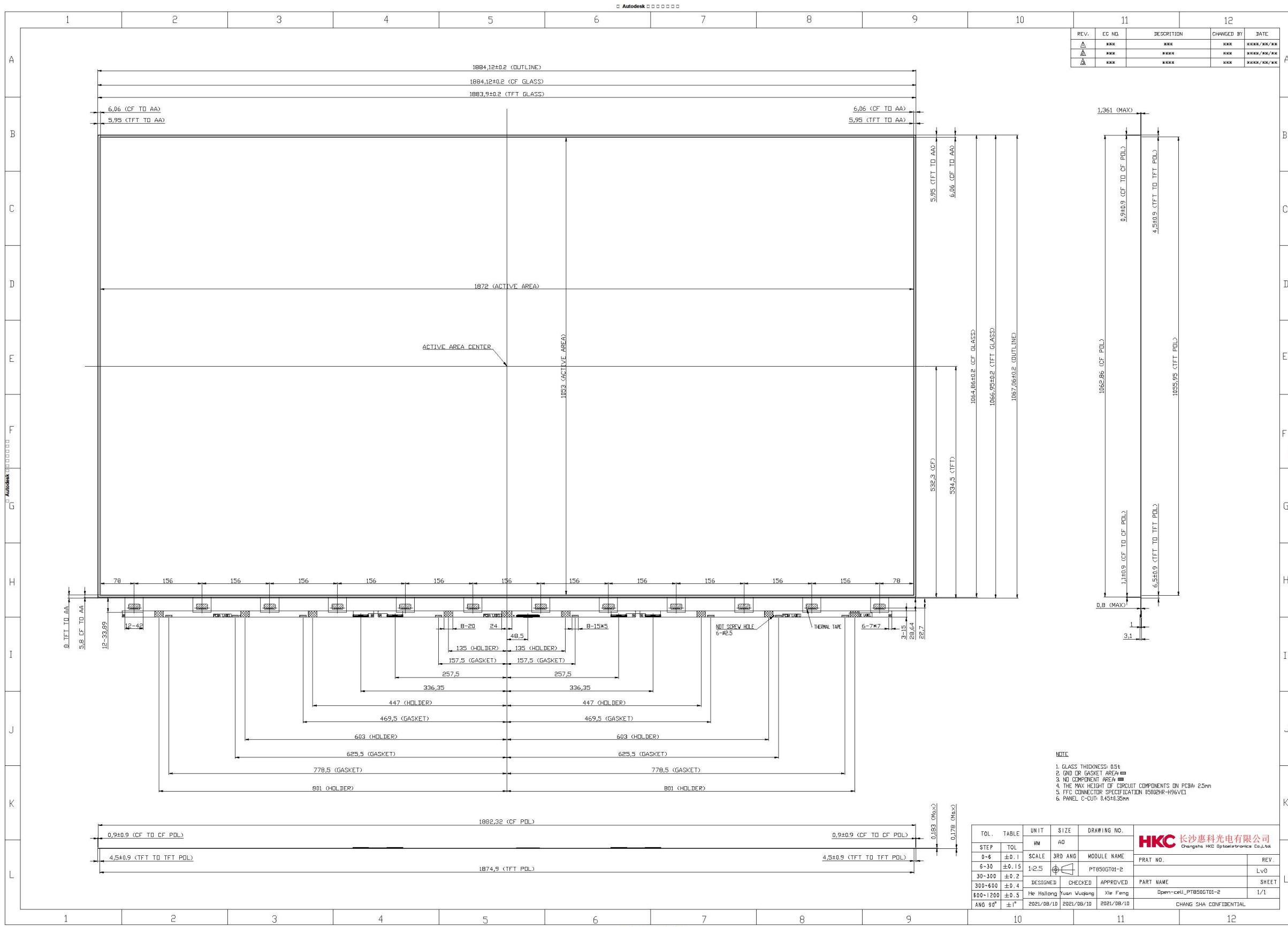


Fig 4.4 Definition of Viewing angle

## 5. MECHANICAL CHARACTERISTICS

## **5.1 Mechanical Specification**

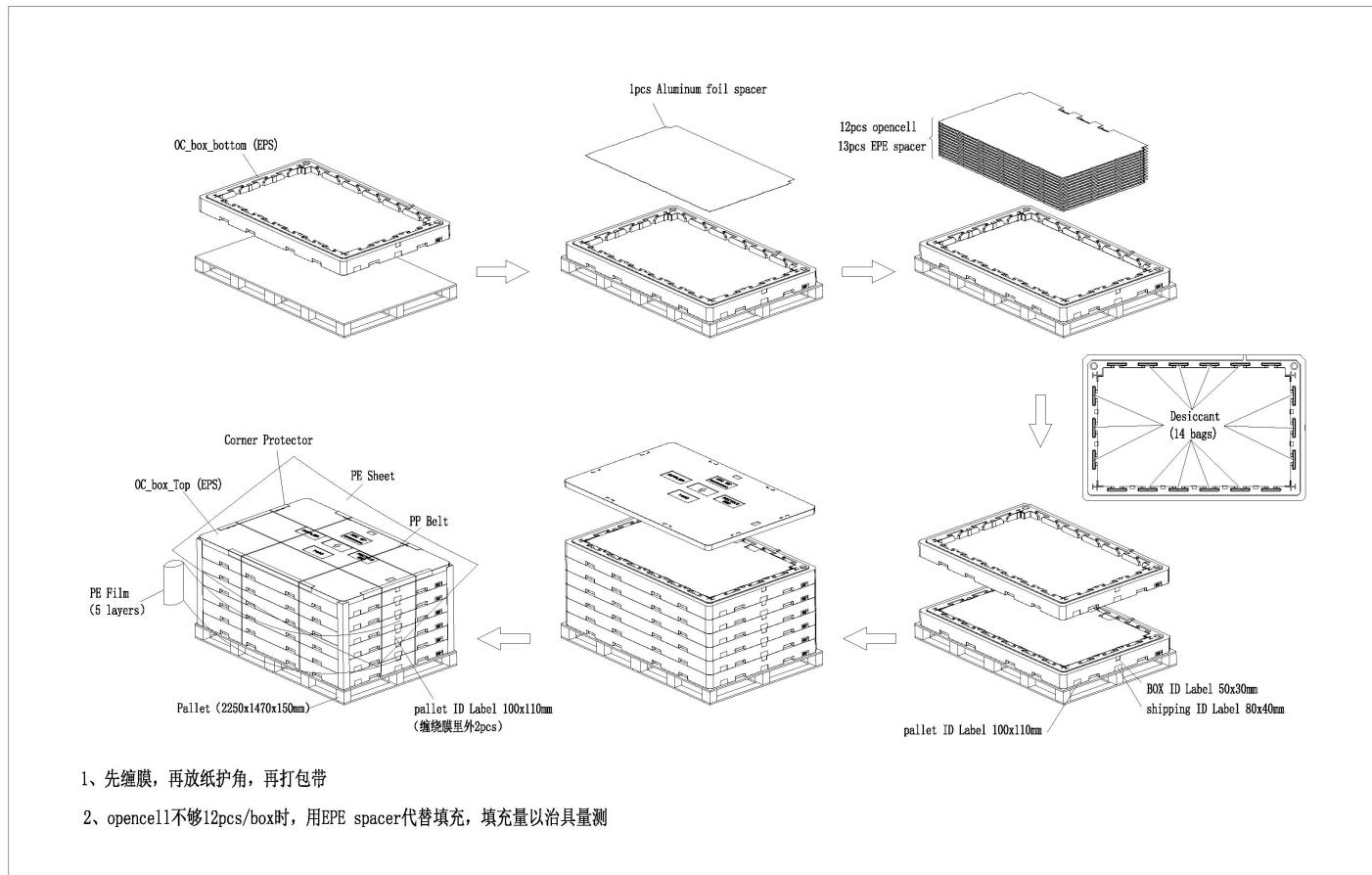


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## 5.2 Packing

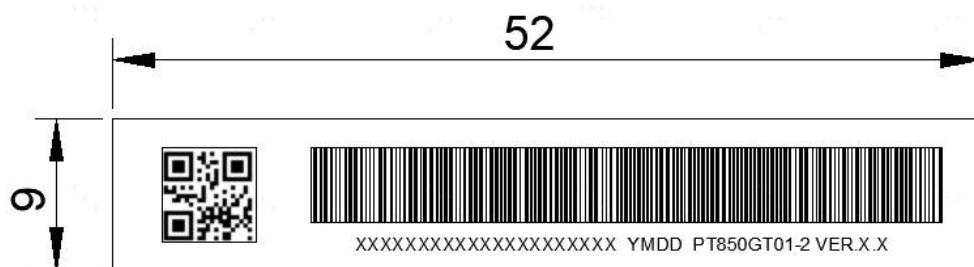
### 5.2.1 Packing Specifications

Item	Specification			
	Quantity	Dimension(mm)	Item	Weight(Kg)
Packing Box	12 pcs/box	2200×1435×158	Net Weight	71.2
			Gross Weight	87.9
Pallet	1	2250×1470×150	Net Weight	44.1
Stack Layer		6		
Boxes per Pallet		6		
Pallet after Packing	72 pcs/pallet	2250x1470x1096	Gross Weight	582.9

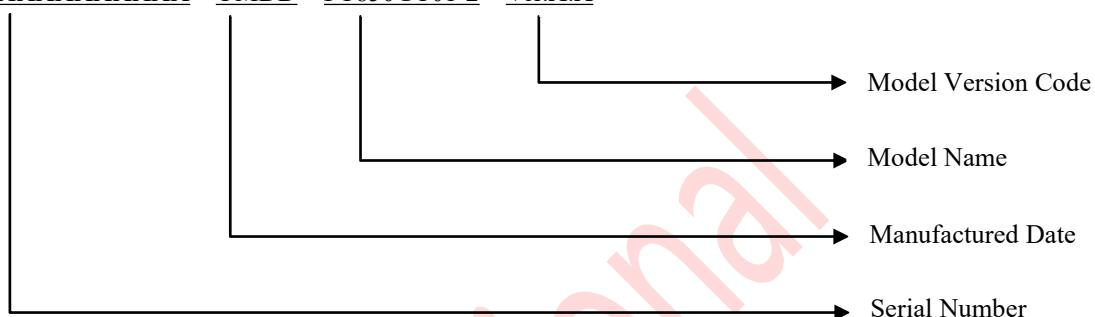


## 6. DEFINITION OF LABELS

### 6.1 Open Cell Label



XXXXXXXXXXXXXXXXXXXX YMDD PT850GT01-2 Ver.X.X



Serial Number: XXXXXXXXXXXX XXXXXXXXXX



Manufactured Date: Y M DD



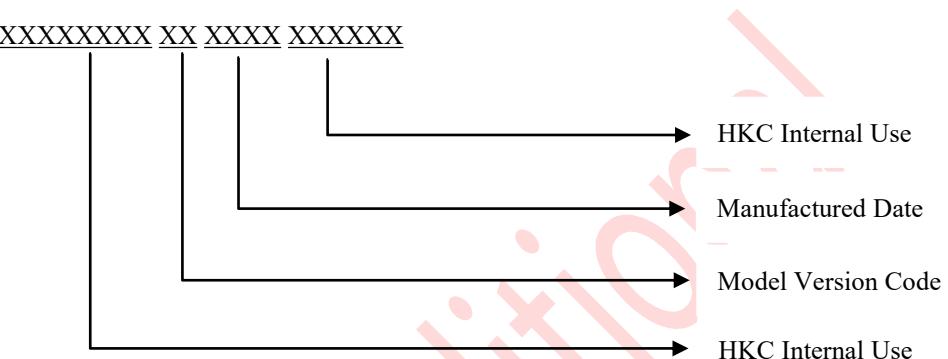
Model Name: PT850GT01-2

Model Version Code: Ver.X.X, for example: 0.0,0.1...,1.0,1.1...,2.0,2.1.....

## 6.2 Carton Label



Serial Number: XXXXXXXX XX XXXX XXXXXX

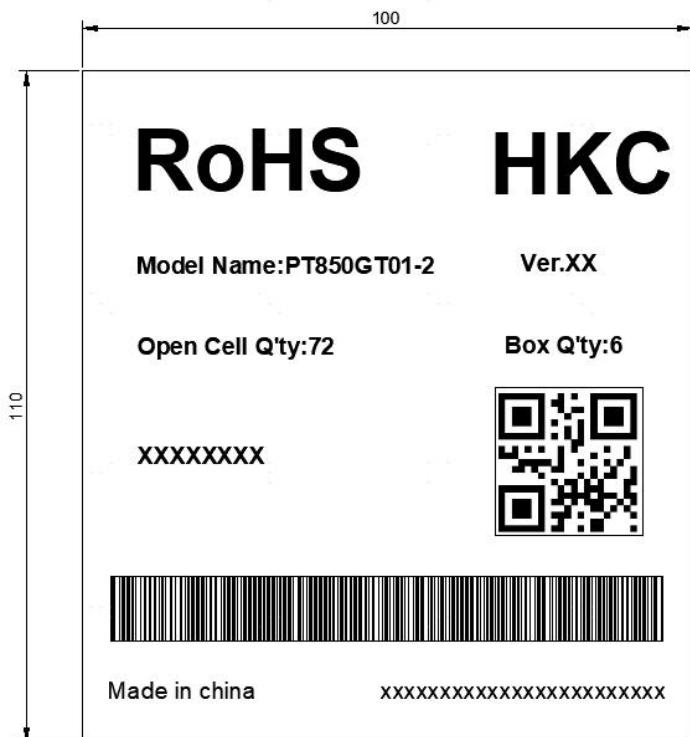


Box ID: XX XXX XXXXX



Model VersionCode: Ver.X.X, for example: 0.0, 0.1..., 1.0, 1.1..., 2.0, 2.1.....

### 6.3 Pallet Label



Serial Number: XXXXXXXX XX XXXX XXXX XXXXXX



Pallet ID: XXXXXXXX

## 7. PRECAUTION

Please pay attention to the followings when a TFT-LCD cell is used, handled and mounted.

### 7.1 Unpacking

Should use immediately after unpacking TFT -LCD cell to prevent the terminal corrosion.

Protection film for a polarizer on a TFT open cell should be slowly peeled off so that the electrostatic charge can be minimized.

Source PCB should be connected to the ground when peel off the protection film.

The protection film should not be contacted to the driver during peeling off.

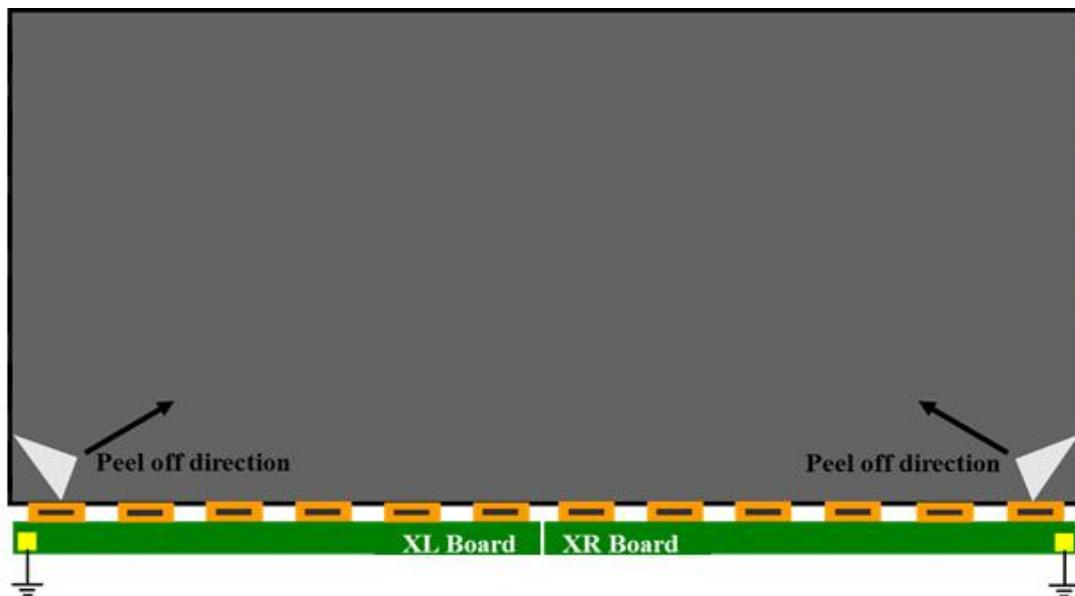


Fig 7.1 Unpacking

### 7.2 Storage Test

Any attachment on polarizer of open-cell,such as tape,is forbidden and not recommend,especially under the high temperature and high humidity environment.

## 8. GP REQUIREMENT

- a) RoHS, Directive 2011/65/EU of the European Parliament and council of 1 July 2011
- b) RoHS, Directive (EU) 2015/863 of the European Parliament and council of 31 March 2015
- c) PPW, Directive 94/62/EC on packaging and packaging waste with amendment(EU)2018/852

Conditional